SA.45s CSAC and RoHS CSAC Options 001 and 003

Chip-Scale Atomic Clock



Features

- Power consumption <120 mW
- Less than 17 cc volume,
 1.6" × 1.39" × 0.45"
- 10 MHz CMOS-compatible output
- 1PPS output and 1PPS input for synchronization
- RS-232 interface for monitoring and control
- Short term stability (Allan Deviation) of 3.0×10^{-10} at τ =1 sec
- Applications¹
- GPS receivers
- Backpack radios
- Anti-IED jamming systems
- Autonomous sensor networks
- Unmanned vehicles
- Underwater sensor systems
- Stability for various other communication and transmission applications
- RoHS-Compliant CSAC
 - RoHS 2 (Directive 2011/65/EU)
 - Wide storage temperature: 100 °C

¹The CSAC is not tested, qualified, or rated for space applications.

With an extremely low power consumption of <120 mW and a volume of <17 cc, the Microchip SA.45s Chip Scale Atomic Clock (CSAC) brings the accuracy and stability of an atomic clock to portable applications for the first time. The CSAC is also available in a RoHS-compliant form.

The SA.45s provides RF and 1PPS outputs at standard CMOS levels, with short-term stability (Allan Deviation) of 3.0×10^{-10} at $\tau = 1$ sec, typical longterm aging of $<9 \times 10^{-10}$ /month, and maximum frequency change of $\pm 5 \times 10^{-10}$ over an operating temperature range of -10° C to 70° C.

The SA.45s CSAC accepts a 1PPS input that may be used to synchronize the unit's 1PPS output to an external reference clock with ± 100 ns accuracy. It also use the 1PPS input to discipline its phase and frequency to within 1 ns and 1.0 \times 10^{-12} , respectively.

A standard CMOS-level RS-232 serial interface is built in to the SA.45s. This is used to control and calibrate the unit and also to provide a comprehensive set of status monitors. The interface is also used to set and read the CSAC's internal time-of-day clock.





Specifications¹

Electrical

RF Outputs		
Frequency	10 MHz (option 001)	
	16.384 MHz (option 003)	
Format	CMOS	
Amplitude	0 V to VCC	
Load Impedance	1 MΩ 1	
Quantity	·	
1PPS Output		
Rise/fall Time		
(10%–90%) at Load	<10 ns	
Capacitance 10 pF	100 µs (Option 001)	
Pulse Width	97.656 μs (Option 003)	
Level	0 V to VCC	
Logic High (VOH) Min	2.80 V	
Logic Low (VOL) Max	0.30 V	
Load Impedance	1 ΜΩ	
Quantity	1	
1P	PS Input	
Format	Rising edge	
Low Level	<0.5 V	
High Level	2.5 V to VCC	
Load Impedance	1 MΩ 1	
Quantity	·	
Serial Co	mmunications	
Protocol	RS-232	
Format	CMOS 0 V to VCC	
Tx/Rx Impedance	1 ΜΩ	
Baud Rate	57600	
Built-In Test Equ	uipment (BITE) Output	
Format	CMOS 0 V to VCC	
Load Impedance	1 ΜΩ	
Logic	0= Normal operation	
LUBIC	1= Alarm	
Pov	wer Input	
Operating	<120 mW	
Warmup	<140 mW	
Input Voltage (VCC)	3.3 ± 0.1 VDC	
1 At input voltage V_{CC} = 3.3 V_{DC} and ambier	nt temperature = 25 °C, unless otherwise specified.	

Environmental

Specification	Details
Operating Temperature	–10 °C to 70 °C
Maximum Frequency Change over Operating Temp Range (Maximum Rate of Change 0.5 °C per Minute)	±5 × 10 ⁻¹⁰
Frequency Change Over Allowable Input Voltage Range	±4 × 10 ⁻¹⁰
Magnetic sensitivity (≤2.0 Gauss)	±9 × 10 ⁻¹¹ /Gauss
Radiated Emissions	Compliant to FCC part 15, Class B, when mounted properly onto host PCB
Vibration	Maintains lock under MIL-STD- 810G, Operational, 7.7 grms per Figure 514.7E-1. Category 24
Humidity	0%–95% RH per MIL-STD-810, Method 507.4
Storage and Tran	sport (Non-operating)
Temperature	−55 °C to 85 °C
Temperature (RoHS- Compliant)	-55 °C to 100 °C
Vibration	MIL-STD-810G, 7.7 grms per Figure 514.7E-1. Category 24
Shock	MIL-STD-202-213A, Condition E, 1000 g

Performance Parameters

Specification	Details
Warm-up Time	<180 s
Analog Tuning	Range: $\pm 2.2 \times 10^{-8}$ Resolution: 1×10^{-11} Input: $0 \text{ V}-2.5 \text{ V}$ into $100 \text{ k}\Omega$
Digital Tuning	Range: $\pm 1 \times 10^{-6}$ Resolution: 1×10^{-12}



Phase Noise (SSB)

Frequency	Option 001	Option 003
1 Hz	<-50 dBc/Hz	<-46 dBc/Hz
10 Hz	<-70 dBc/Hz	<-66 dBc/Hz
100 Hz	<-113 dBc/Hz	<-104 dBc/Hz
1 kHz	<-128 dBc/Hz	<-128 dBc/Hz
10 kHz	<-135 dBc/Hz	<-135 dBc/Hz
100 kHz	<-140 dBc/Hz	<-140 dBc/Hz
Frequency Accuracy		
Maximum Offset at Shipment	±5 × 10 ⁻¹¹	
Maximum Retrace (48 hrs Off)	±5 × 10 ⁻¹⁰	

Aging

1 PPS Sync

Type ²	SA.45s
Monthly	<9 × 10 ⁻¹⁰
Yearly	<1 × 10 ⁻⁸

±100 ns

Short-Term Stability (Allan Deviation)

Туре	SA.45s
$\tau = 1 s$	3 × 10 ⁻¹⁰
$\tau = 10 \text{ s}$	1×10^{-10}
$\tau = 100 \text{ s}$	3×10^{-11}
$\tau = 1000 \text{ s}$	1×10^{-11}

Physical

Туре	SA.45s
Weight	<35 g (<1.23 oz)
Size	1.6" × 1.39" × 0.45"
MTBF	>100,000 hours
RoHS	RoHS 2 (Directive 2011/65/EU)

Solder

Туре	Details
Standard	Hand solder using 63/37 tin/lead solder with maximum soldering tip of 329 °C (625 °F)
RoHS- Compliant	Hand solder using 96.5/3/0.5 tin/ silver/copper with maximum solder tip temperature of 370 °C (698 °F) and a dwell time of <5 s.

Ordering Information

Part Number	Description	Output Frequency
090-02984-001	Chip-scale atomic clock option 001	10 MHz
090-02984-003	Chip-scale atomic clock option 003	16.384 MHz
090-03240-001	RoHS-compliant chip- scale atomic clock option 001	10 MHz
090-03240-003	RoHS-compliant chip- scale atomic clock option 003	16.384 MHz



²After 30 days of continuous operation.